


Input Voltage = 9Vin - 16Vin

16V-40Vout @ 10A

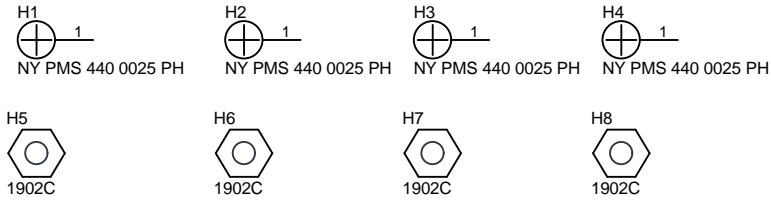
	Caution	Caution Hot surface. Contact may cause burns. Do not touch

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Orderable: ChangeMe!	Designed for: Public Release	Mod. Date: 12/14/2017
TID #: TIDA-01610	Project Title: Automotive Tracking Boost Based on PMP2112	
Number: TIDA-01610	Rev: A	Sheet Title:
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 1 of 2
Drawn By:	File: TIDA-01610_Sheet1.SchDoc	Size: B
Engineer: Xinyu Dai	Contact: http://www.ti.com/support	



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PCB Number: TIDA-01610
 PCB Rev: A


Logo2
 PCB
 LOGO

Logo3
 PCB
 LOGO



Variant/Label Table	
Variant	Label Text
001	

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TID #: TIDA-01610	Project Title: Automotive Tracking Boost Based on PMP21112		
Number: TIDA-01610	Rev: A	Sheet Title:	
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 2 of 2	
Drawn By: Xinyu Dai	File: TIDA-01610_Sheet2_Hardware.SchDoc	Size: B	
Engineer: Xinyu Dai	Contact: http://www.ti.com/support		

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Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
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